

### **MOSFET**

Metal Oxide Semiconductor Field Effect Transistor

CoolMOS™ C7

600V CoolMOS™ C7 Power Transistor IPW60R060C7

## **Data Sheet**

Rev. 2.0 Final





### 1 Description

CoolMOS™ C7 is a revolutionary technology for high voltage power MOSFETs, designed according to the superjunction (SJ) principle and pioneered by Infineon Technologies.

600V CoolMOS™ C7 series combines the experience of the leading SJ MOSFET supplier with high class innovation.

The 600V C7 is the first technology ever with R<sub>DS(on)</sub>\*A below 10hm\*mm².

#### **Features**

- Suitable for hard and soft switching (PFC and high performance LLC)
- Increased MOSFET dv/dt ruggedness to 120V/ns
- Increased efficiency due to best in class FOM R<sub>DS(on)</sub>\*E<sub>oss</sub> and R<sub>DS(on)</sub>\*Q<sub>g</sub>
- Best in class R<sub>DS(on)</sub> /package
- Qualified for industrial grade applications according to JEDEC (J-STD20 and JESD22)

#### **Benefits**

- Increased economies of scale by use in PFC and PWM topologies in the application
- Higher dv/dt limit enables faster switching leading to higher efficiency
- Enabling higher system efficiency by lower switching losses
- Increased power density solutions due to smaller packages
- Suitable for applications such as server, telecom and solar
- Higher switching frequencies possible without loss in efficiency due to low Eoss and Qg

### **Applications**

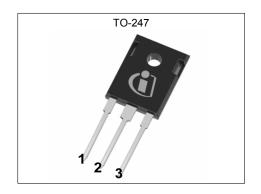
PFC stages and PWM stages (TTF, LLC) for high power/performance SMPS e.g. Computing, Server, Telecom, UPS and Solar.

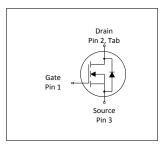
Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.

**Table 1** Key Performance Parameters

10.0.0		
Parameter	Value	Unit
V <sub>DS</sub> @ T <sub>j,max</sub>	650	V
R <sub>DS(on),max</sub>	60	m $Ω$
$Q_{g.typ}$	68	nC
I <sub>D,pulse</sub>	135	A
I <sub>D,continuous</sub> @ T <sub>j</sub> <150°C	54	A
E <sub>oss</sub> @400V	8.1	μЈ
Body diode di/dt	420	A/µs

Type / Ordering Code	Package	Marking	Related Links
IPW60R060C7	PG-TO 247	60C7060	see Appendix A

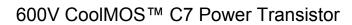














### IPW60R060C7

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**2** Maximum ratings at  $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

Damain Adam	0	Values					
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	-	-	35 22	А	T <sub>C</sub> =25°C T <sub>C</sub> =100°C	
Pulsed drain current <sup>2)</sup>	I <sub>D,pulse</sub>	-	-	135	Α	T <sub>C</sub> =25°C	
Avalanche energy, single pulse	<b>E</b> <sub>AS</sub>	-	-	159	mJ	I <sub>D</sub> =6.4A; V <sub>DD</sub> =50V; see table 10	
Avalanche energy, repetitive	<b>E</b> AR	-	-	0.80	mJ	I <sub>D</sub> =6.4A; V <sub>DD</sub> =50V; see table 10	
Avalanche current, single pulse	I <sub>AS</sub>	-	-	6.4	Α	-	
MOSFET dv/dt ruggedness	dv/dt	-	-	120	V/ns	V <sub>DS</sub> =0400V	
Gate source voltage (static)	V <sub>GS</sub>	-20	-	20	V	static;	
Gate source voltage (dynamic)	V <sub>GS</sub>	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P <sub>tot</sub>	-	-	162	W	<i>T</i> <sub>C</sub> =25°C	
Storage temperature	T <sub>stg</sub>	-55	-	150	°C	-	
Operating junction temperature	T <sub>j</sub>	-55	-	150	°C	-	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Continuous diode forward current	I <sub>S</sub>	-	-	35	Α	<i>T</i> <sub>C</sub> =25°C	
Diode pulse current <sup>2)</sup>	I <sub>S,pulse</sub>	-	-	135	Α	<i>T</i> <sub>C</sub> =25°C	
Reverse diode dv/dt <sup>3)</sup>	dv/dt	-	-	20	V/ns	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <=9.9A, $T_{\rm j}$ =25°C see table 8	
Maximum diode commutation speed	di <sub>f</sub> /dt	-	-	420	A/μs	$V_{\rm DS}$ =0400V, $I_{\rm SD}$ <=9.9A, $T_{\rm j}$ =25°C see table 8	
Insulation withstand voltage	V <sub>ISO</sub>	-	-	n.a.	V	V <sub>rms</sub> , T <sub>C</sub> =25°C, t=1min	

 $<sup>^{1)}</sup>$  Limited by  $T_{j\,\text{max}}.$   $^{2)}$  Pulse width  $t_p$  limited by  $T_{j,\text{max}}$   $^{3)}$  Identical low side and high side switch



### 3 Thermal characteristics

### **Table 3** Thermal characteristics

Parameter	Cumbal	Values			I Imit	Nata / Tank Canadition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	0.772	°C/W	-
Thermal resistance, junction - ambient	R <sub>thJA</sub>	-	-	62	°C/W	leaded
Thermal resistance, junction - ambient for SMD version	R <sub>thJA</sub>	-	-	-	°C/W	n.a.
Soldering temperature, wavesoldering only allowed at leads	T <sub>sold</sub>	-	-	260	°C	1.6mm (0.063 in.) from case for 10s



# **4 Electrical characteristics** at $T_j$ =25°C, unless otherwise specified

Table 4 **Static characteristics** 

Parameter	Courado a l	Values			1114	
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	600	-	-	V	$V_{GS}$ =0V, $I_D$ =1mA
Gate threshold voltage	$V_{(GS)th}$	3	3.5	4	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=0.8{\rm mA}$
Zero gate voltage drain current	I <sub>DSS</sub>	-	- 10	1 -	μΑ	V <sub>DS</sub> =600, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C V <sub>DS</sub> =600, V <sub>GS</sub> =0V, T <sub>j</sub> =150°C
Gate-source leakage current	I <sub>GSS</sub>	-	-	100	nA	V <sub>GS</sub> =20V, V <sub>DS</sub> =0V
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	0.052 0.115	0.060	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =15.9A, T <sub>j</sub> =25°C V <sub>GS</sub> =10V, I <sub>D</sub> =15.9A, T <sub>j</sub> =150°C
Gate resistance	R <sub>G</sub>	-	0.8	-	Ω	f=1MHz, open drain

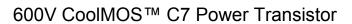
**Dynamic characteristics** Table 5

Parameter	0		Values			
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	2850	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, f=250kHz
Output capacitance	Coss	-	54	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =400V, <i>f</i> =250kHz
Effective output capacitance, energy related <sup>1)</sup>	C <sub>o(er)</sub>	-	101	-	pF	V <sub>GS</sub> =0V, V <sub>DS</sub> =0400V
Effective output capacitance, time related <sup>2)</sup>	C <sub>o(tr)</sub>	-	1050	-	pF	$I_D$ =constant, $V_{GS}$ =0V, $V_{DS}$ =0400V
Turn-on delay time	$t_{\sf d(on)}$	-	15.5	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =15.9A, $R_{\rm G}$ =3.3 $\Omega$ ; see table 9
Rise time	t <sub>r</sub>	-	11	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =15.9A, $R_{\rm G}$ =3.3 $\Omega$ ; see table 9
Turn-off delay time	$t_{ m d(off)}$	-	79	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =15.9A, $R_{\rm G}$ =3.3 $\Omega$ ; see table 9
Fall time	t <sub>f</sub>	-	4	-	ns	$V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =15.9A, $R_{\rm G}$ =3.3 $\Omega$ ; see table 9

Table 6 Gate charge characteristics

Parameter	Symphol		Values			Nata / Tant Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	14	-	nC	V <sub>DD</sub> =400V, I <sub>D</sub> =15.9A, V <sub>GS</sub> =0 to 10V
Gate to drain charge	Q <sub>gd</sub>	-	23	-	nC	V <sub>DD</sub> =400V, I <sub>D</sub> =15.9A, V <sub>GS</sub> =0 to 10V
Gate charge total	Qg	-	68	-	nC	V <sub>DD</sub> =400V, I <sub>D</sub> =15.9A, V <sub>GS</sub> =0 to 10V
Gate plateau voltage	V <sub>plateau</sub>	-	5.0	-	V	$V_{\rm DD}$ =400V, $I_{\rm D}$ =15.9A, $V_{\rm GS}$ =0 to 10V

 $<sup>^{1)}</sup>$   $C_{\text{o(er)}}$  is a fixed capacitance that gives the same stored energy as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 400V  $^{2)}$   $C_{\text{o(tr)}}$  is a fixed capacitance that gives the same charging time as  $C_{\text{oss}}$  while  $V_{\text{DS}}$  is rising from 0 to 400V





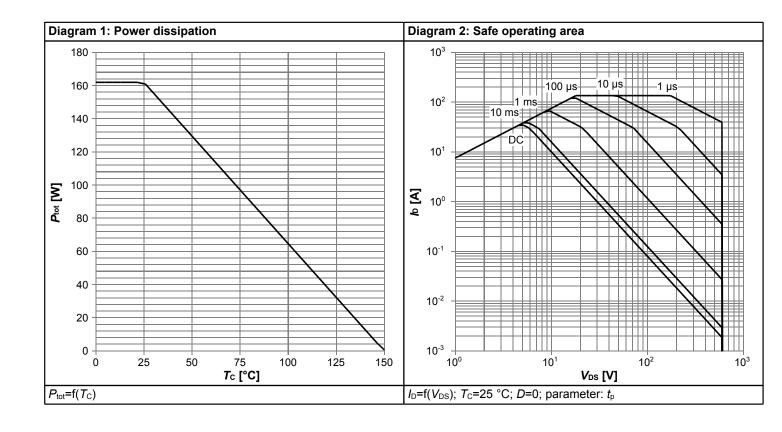
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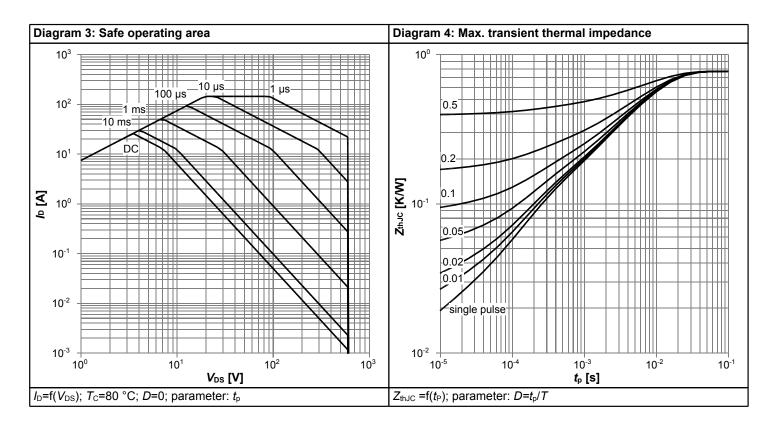
### Table 7 Reverse diode characteristics

Parameter	Cymbal	Values			Unit	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Oilit	Note / Test Condition
Diode forward voltage	V <sub>SD</sub>	-	0.9	-	V	V <sub>GS</sub> =0V, I <sub>F</sub> =15.9A, T <sub>j</sub> =25°C
Reverse recovery time	t <sub>rr</sub>	-	390	-	ns	$V_R$ =400V, $I_F$ =15.9A, $di_F/dt$ =100A/ $\mu$ s; see table 8
Reverse recovery charge	Q <sub>rr</sub>	-	6	-	μC	$V_R$ =400V, $I_F$ =15.9A, $di_F/dt$ =100A/ $\mu$ s; see table 8
Peak reverse recovery current	I <sub>rrm</sub>	-	32	-	Α	$V_R$ =400V, $I_F$ =15.9A, $di_F/dt$ =100A/ $\mu$ s; see table 8

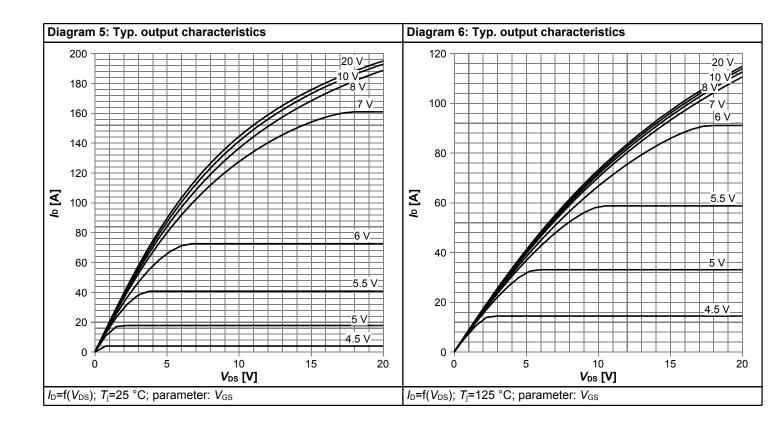


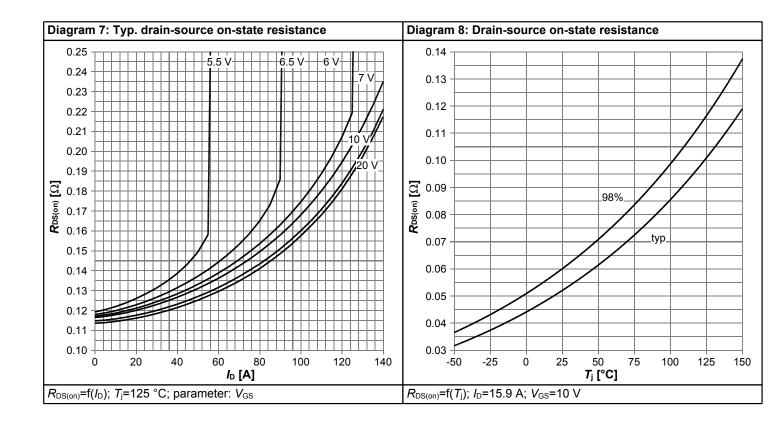
### 5 Electrical characteristics diagrams



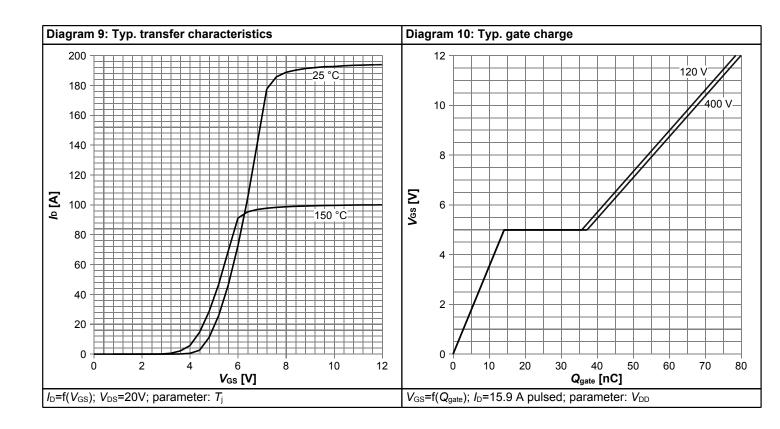


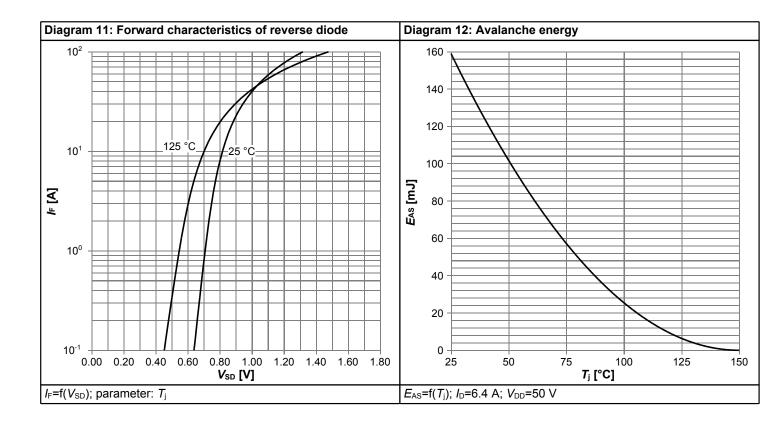




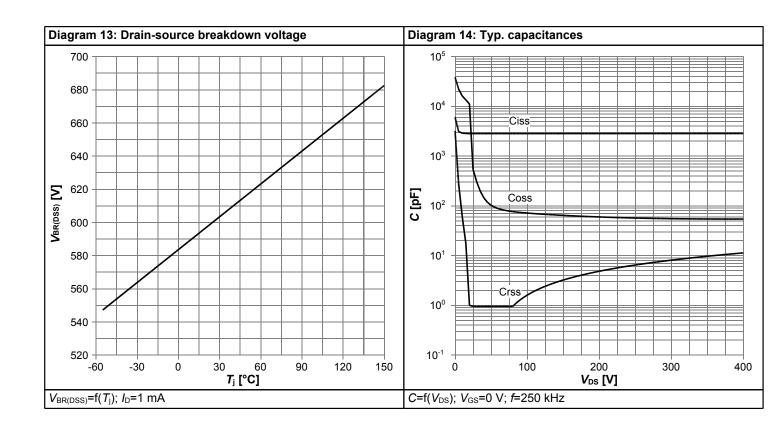


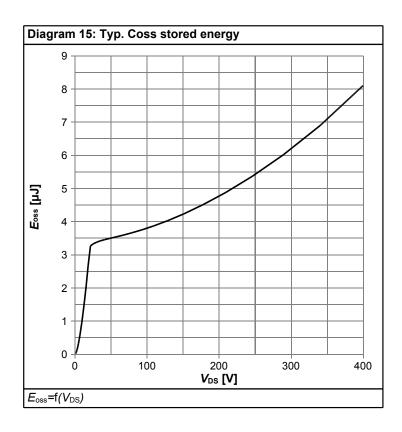














### 6 Test Circuits

Table 8 Diode characteristics

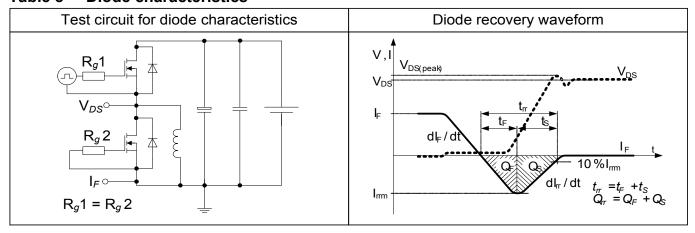


Table 9 Switching times

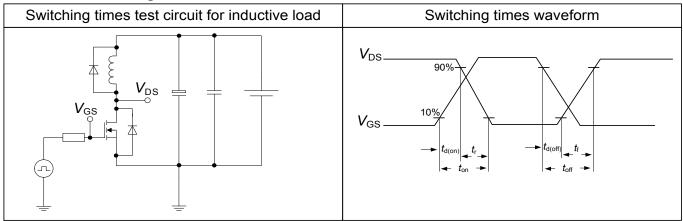
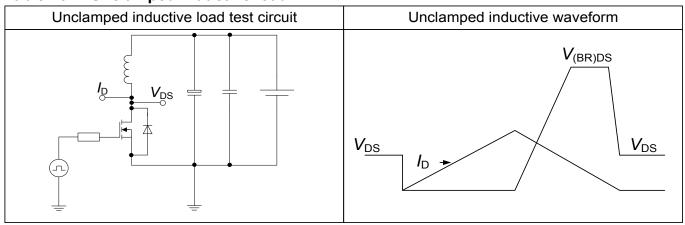


Table 10 Unclamped inductive load





### 7 Package Outlines

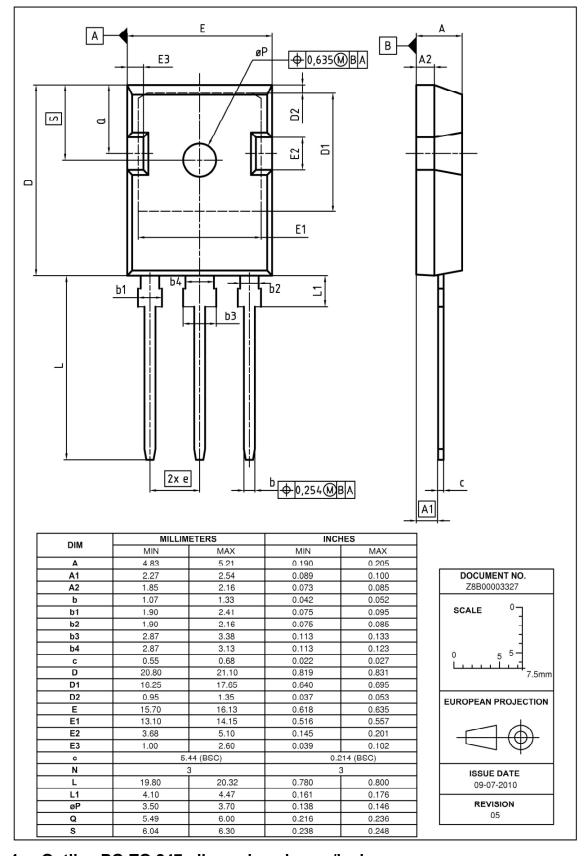


Figure 1 Outline PG-TO 247, dimensions in mm/inches



### 8 Appendix A

### Table 11 Related Links

- IFX CoolMOS<sup>™</sup> C7 Webpage: <u>www.infineon.com</u>
- IFX CoolMOS<sup>™</sup> C7 application note: <u>www.infineon.com</u>
- IFX CoolMOS<sup>™</sup> C7 simulation model: www.infineon.com
- IFX Design tools: www.infineon.com



#### 600V CoolMOS™ C7 Power Transistor

IPW60R060C7

#### **Revision History**

IPW60R060C7

Revision: 2015-11-30, Rev. 2.0

Previous Revision						
Revision	Date	Subjects (major changes since last revision)				
2.0	2015-11-30	Release of final version				

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